

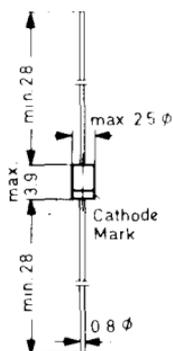
ZPU 100 ... ZPU 180 (1.3 W, 10%)

Silicon Planar Power Zener Diodes

for use in stabilizing and clipping circuits with higher power rating. The Zener voltage are graded according to the international E 12 standard (tolerance $\pm 10\%$). Smaller voltage tolerances on request.

Glass case JEDEC DO-41
54 B 2 according to DIN 41 880
Weight approx. 0.35 g
Dimensions in mm

These diodes are delivered taped.
Details see "Taping".



Maximum Ratings

Zener current see table on next page

Power dissipation @ $T_{amb} = 25^\circ\text{C}$	P_{tot}	1.3 1)	W
Junction temperature	T_j	200	$^\circ\text{C}$
Storage temperature range	T_S	-55...+200	$^\circ\text{C}$

Characteristics @ $T_{amb} = 25^\circ\text{C}$

Thermal resistance junction to ambient air	R_{thA}	< 130 1)	$^\circ\text{C}/\text{W}$
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Type	Zener voltage 2) @ $I_Z \text{ test}$ $V_Z \text{ V}$	Dynamic resistance @ $I_Z \text{ test}$ $f = 1 \text{ kHz}$ $r_{zj} \Omega$	Temp. coeff. of Zener volt. @ $I_Z \text{ test}$ α_{VZ} $10^{-4}/^\circ\text{C}$	Test current $I_Z \text{ test}$ mA	Reverse voltage @ $I_R = 0.5 \mu\text{A}$ $V_R \text{ V}$	Admissible Zener current 1) @ $T_{amb} = 45^\circ\text{C}$ $I_Z \text{ mA}$
ZPU 100	88...110	140 (<300)	+9...+13	5	>75	10
ZPU 120	107...134	170 (<330)	+9...+13	5	>90	8.5
ZPU 150	130...165	200 (<360)	+9...+13	5	>112	7
ZPU 180	160...200	220 (<380)	+9...+13	5	>134	5.5

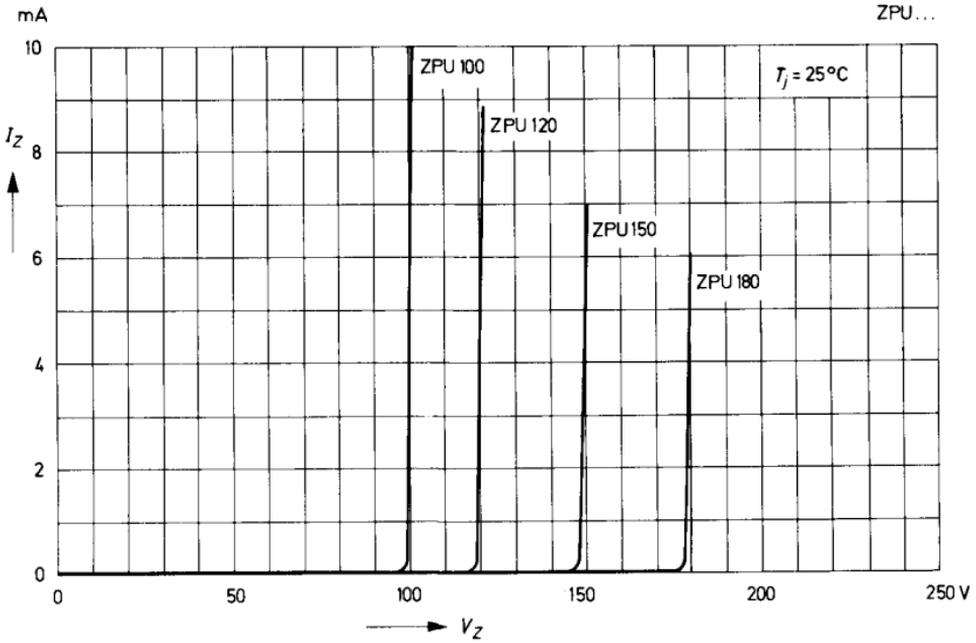
1) Valid provided that leads are kept at ambient temperature at a distance of 10 mm from case.

2) tested with pulses

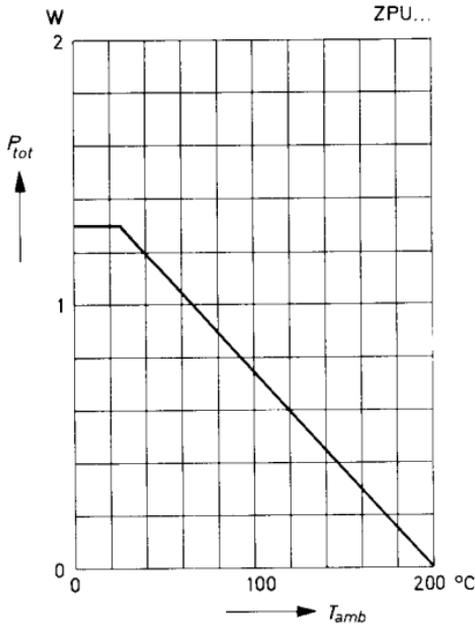
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Breakdown characteristics

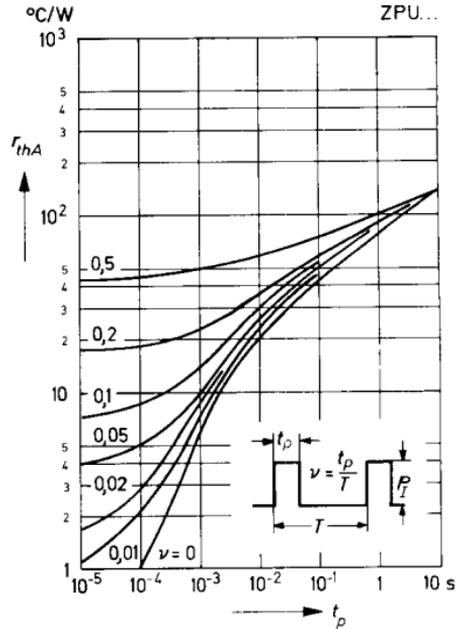
@ $T_j = \text{constant}$ (pulsed)



Admissible power dissipation versus ambient temperature (see note 1) on previous page)

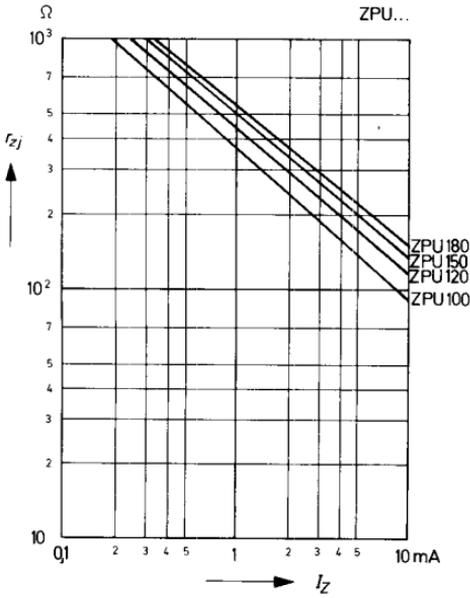


Pulse thermal resistance versus pulse duration (see note 1) on previous page)



ZPU 100 ... ZPU 180 (1.3 W, 10%)

**Dynamic resistance
versus
Zener current**



**Thermal resistance
versus
lead length**

